

ATTACHMENT A
Amendments to the Claims

This listing of claims will replace all prior versions, and listings, of claims in the application.

1. (Currently Amended) Method of producing a generally flat, planar detail, such as an electronic product or a component of such, of a plastically formable material, ~~characterised~~characterized in that it comprises the steps:
 - first applying an adhesive cover layer containing ~~eelour~~color pigment and a circuit comprising electrical and/or optical conductors, on at least one of the surfaces of the detail, and
 - ~~the forming~~forming the detail plastically in order to obtain its end form.
2. (Currently Amended) Method according to claim 1 ~~or 2~~, ~~characterised~~characterized in that the cover layer is a ~~eeloured~~colored cover layer.
3. (Currently Amended) Method according to ~~any of the preceding claims~~ claim 1, ~~characterised~~characterized in that the cover layer is arranged with signs and symbols.
4. (Currently Amended) Method according to claim 1, ~~characterised~~characterized in that the plastic forming comprises stamping, drawing, bending, drilling, or broaching.
5. (Currently Amended) Method according to claim 1, ~~characterised~~characterized in the further step of cleaning the detail before the application of the cover layer.
6. (Currently Amended) Device for producing a generally flat, planar detail, such as an electronic product or a component of such, of a plastically formable material, ~~characterised~~characterized in that it comprises:
 - means for first applying an adhesive cover layer containing ~~eelour~~color pigment and a circuit comprising electrical and/or optical conductors, on at least one of the surfaces of the detail, and
 - means for subsequent forming of the detail plastically in order to obtain its end form.

7. (Currently Amended) Device according to claim 6, ~~characterised~~characterized in that it comprises means for cleaning the detail before the application of the cover layer.

8. (Currently Amended) Cover layer to be used in the method according to ~~any of the claims 1-5~~ claim 1, ~~characterised~~characterized in that it comprises at least one circuit.

9. (Currently Amended) Cover layer according to claim 8, ~~characterised~~characterized in that the circuit comprises functional components.

10. (Original) Cover layer according to claim 9, characterized in that the functional components are electrical or optical.

11. (Currently Amended) Cover layer according to claim 9, ~~characterised~~characterized in that the components comprise processors, memory units, light means, audio means, active and passive components, displays, keypads and the like.

12. (Currently Amended) Detail produced of a cover layer according to ~~any of the claims 8 to 10~~ claim 8 and by the method ~~according to claim 1~~ of producing a generally flat, planar detail, such as an electronic product or a component of such, of a plastically formable material, characterized in that it comprises the steps of first applying an adhesive cover layer containing color pigment and a circuit comprising electrical and/or optical conductors, on at least one of the surfaces of the detail, and then forming the detail plastically in order to obtain its end form.